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APPLICATION NO.	F	ILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/736,709	12/17/2003		Yong-Sung Ham	0630-1835P	5806
2292	7590	12/20/2005		EXAM	INER
BIRCH ST PO BOX 74		KOLASCH & BIR	CHACKO DAVIS, DABORAH		
	FALLS CHURCH, VA 22040-0747				PAPER NUMBER
	,			1756	· · · · · · · · · · · · · · · · · · ·

DATE MAILED: 12/20/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)					
	10/736,709	HAM, YONG-SUNG					
Office Action Summary	Examiner	Art Unit					
	Daborah Chacko-Davis	1756					
The MAILING DATE of this communication a Period for Reply	ppears on the cover sheet with th	he correspondence address					
A SHORTENED STATUTORY PERIOD FOR REF WHICHEVER IS LONGER, FROM THE MAILING - Extensions of time may be available under the provisions of 37 CFR after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory perions for reply within the set or extended period for reply will, by state that the period for reply within the set or extended period for reply will, by state that the main three months after the main term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNICAT 1.136(a). In no event, however, may a reply but will apply and will expire SIX (6) MONTHS ute, cause the application to become ABAND	TION. be timely filed from the mailing date of this communication. ONED (35 U.S.C. § 133).					
Status							
1) Responsive to communication(s) filed on 29	September 2005.						
2a) ☐ This action is FINAL . 2b) ☑ The	This action is FINAL . 2b)⊠ This action is non-final.						
	·— · · · · · · · · · · · · · · · · · ·						
closed in accordance with the practice unde	r Ex parte Quayle, 1935 C.D. 11	, 453 O.G. 213.					
Disposition of Claims							
4) Claim(s) 1-18 is/are pending in the application	on.						
4a) Of the above claim(s) is/are withd	4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.							
6) Claim(s) <u>1-18</u> is/are rejected.							
7) Claim(s) is/are objected to.							
8) Claim(s) are subject to restriction and	l/or election requirement.						
Application Papers							
9) The specification is objected to by the Exami	ner.						
10)☐ The drawing(s) filed on is/are: a)☐ a	ccepted or b) objected to by t	he Examiner.					
Applicant may not request that any objection to the	ne drawing(s) be held in abeyance.	See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the corre	,	•					
11) ☐ The oath or declaration is objected to by the	Examiner. Note the attached Of	fice Action or form PTO-152.					
Priority under 35 U.S.C. § 119							
 12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority docume 2. Certified copies of the priority docume 3. Copies of the certified copies of the priority docume 	ents have been received. ents have been received in Appli	cation No					
application from the International Bure	, , , ,						
* See the attached detailed Office action for a li	st of the certified copies not rece	eived.					
·							
Attachment(s)	🗖 .						
1) X Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	4) ∐ Interview Sumn Paper No(s)/Ma						
Information Disclosure Statement(s) (PTO-1449 or PTO/SB/0 Paper No(s)/Mail Date		nal Patent Application (PTO-152)					

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DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.
- 2. Claims 1-18, are rejected under 35 U.S.C. 102(e) as being anticipated by U.S. Patent No. 6722760 (Baek et al).

Baek, in col 1, lines 12-15, in col 2, lines 1-67, and in figures 2A through 2C, discloses a method of forming a pattern comprising providing a substrate wherein a plurality of panels and process-subjected layers are formed, wherein the substrate includes plurality of areas (forming display device on a large area of the substrate), providing a cliché with recesses (plurality of grooves), filling the recesses with resist, and transferring the resist formed in the recesses of the cliché to the process-subjected layer of the substrate by using a printing roll (transfer roll), with the same width (desired size) as that of the panel in the display device (substrate area), that rotates and contacts the surface of the cliché, and transferring the blanket of the resist formed on the transfer roll to the process-subjected layer by rotating and contacting the surface of the process-subjected layer by rotating and contacting the surface of the process-subjected layer (claims 1-3, 5, 11-12, 17, and 18). Baek, in col 2, lines 54-

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60, discloses that the length of the resist to be transferred (blanket) is the same as the circumference of the transfer roll which in turn is the same as the length of the panel (divided area of the substrate) and that the cliché, and the transfer roll have the same size as that of the panel (divided area of the substrate) (claims 4, 6, 7, and 13). Baek, in col 1, lines 18-67, discloses that the process-subjected layer (etching object layer) may be a metal layer, or a semiconducting layer or an insulating layer such as SiOx or SiNx (claims 8-10, 14-16).

Response to Arguments

3. Applicant's arguments, see Remarks, filed 09/29/2005, with respect to the 102 rejection(s) of claim(s) 1-18, under U. S. Patent Application Publication No. 2003/0124865 have been fully considered and are persuasive. Therefore, the rejection has been withdrawn. However, upon further consideration, a new ground(s) of rejection is made in view of U. S. Patent No. 6,722,760 (Jeong et al).

Conclusion

4. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Daborah Chacko-Davis whose telephone number is (571) 272-1380. The examiner can normally be reached on M-F 9:30 - 6:00. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Mark F Huff can be reached on (571) 272-1385. The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

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Center (EBC) at 866-217-9197 (toll-free).

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business

dcd

June 27, 2005.

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